



深圳市矽源特科技有限公司

ShenZhen ChipSourceTek Technology Co., Ltd.

## CST3134 N-Ch 20V Fast Switching MOSFETs

- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

### CST3134 Product Summary



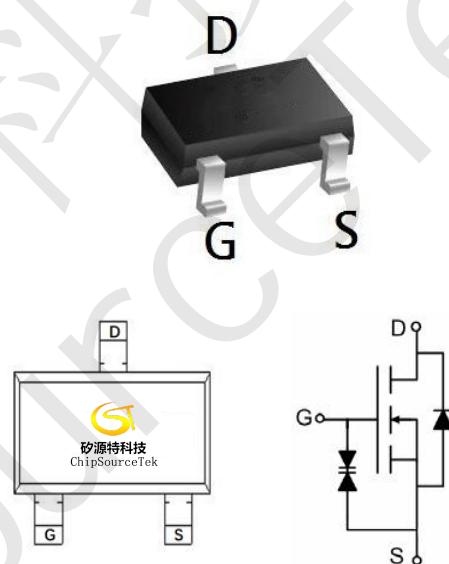
BVDSS	RDS(on)	ID
20V	145mΩ	0.75A

### CST3134 Description

The CST3134 is the high cell density trenched N-ch MOSFETs, which provides excellent RDS(on) and efficiency for most of the small power switching and load switch applications.

The CST3134 meet the RoHS and Green Product requirement with full function reliability approved.

### CST3134 SOT-523-3L top view



### CST3134 Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Max.	Units
$V_{DSS}$	Drain-Source Voltage	20	V
$V_{GSS}$	Gate-Source Voltage	$\pm 10$	V
$I_D$	Continuous Drain Current	$T_A = 25^\circ\text{C}$	A
		$T_A = 100^\circ\text{C}$	A
$I_{DM}$	Pulsed Drain Current <sup>note1</sup>	3	A
$P_D$	Power Dissipation	$T_A = 25^\circ\text{C}$	W
$R_{\theta JA}$	Thermal Resistance, Junction to Case	735	$^\circ\text{C}/\text{W}$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$

TEL: +86-0755-27595155 27595165

FAX: +86-0755-27594792

WEB: [Http://www.ChipSourceTek.com](http://www.ChipSourceTek.com)

E-mail: Sales@ChipSourceTek.com Tony.Wang@ChipSourceTek.com



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**CST3134 Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	20	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=20\text{V}$ , $V_{\text{GS}}=0\text{V}$ ,	-	-	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate to Body Leakage Current	$V_{\text{DS}}=0\text{V}$ , $V_{\text{GS}}= \pm 10\text{V}$	-	-	$\pm 10$	$\mu\text{A}$
<b>On Characteristics</b>						
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_D=250\mu\text{A}$	0.4	0.7	1.0	V
$R_{\text{DS}(\text{on})}$ note2	Static Drain-Source on-Resistance	$V_{\text{GS}}=4.5\text{V}$ , $I_D=0.5\text{A}$	-	145	190	$\text{m}\Omega$
		$V_{\text{GS}}=2.5\text{V}$ , $I_D=0.4\text{A}$	-	225	315	
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=10\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1.0\text{MHz}$	-	60	-	$\text{pF}$
$C_{\text{oss}}$	Output Capacitance		-	22	-	$\text{pF}$
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	12	-	$\text{pF}$
$Q_g$	Total Gate Charge	$V_{\text{DS}}=10\text{V}$ , $I_D=0.75\text{A}$ , $V_{\text{GS}}=4.5\text{V}$	-	1	-	$\text{nC}$
$Q_{\text{gs}}$	Gate-Source Charge		-	0.28	-	$\text{nC}$
$Q_{\text{gd}}$	Gate-Drain("Miller") Charge		-	0.22	-	$\text{nC}$
<b>Switching Characteristics</b>						
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{DS}}=10\text{V}$ , $I_D=0.5\text{A}$ , $R_{\text{GEN}}=10\Omega$ , $V_{\text{GS}}=4.5\text{V}$	-	2	-	ns
$t_r$	Turn-on Rise Time		-	19	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time		-	10	-	ns
$t_f$	Turn-off Fall Time		-	23	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_s$	Maximum Continuous Drain to Source Diode Forward Current		-	-	0.75	A
$I_{\text{SM}}$	Maximum Pulsed Drain to Source Diode Forward Current		-	-	3	A
$V_{\text{SD}}$	Drain to Source Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_s=0.75\text{A}$	-	-	1.2	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. Pulse Test: Pulse Width $\leq 300\mu\text{s}$ , Duty Cycle $\leq 0.5\%$



### CST3134 N-Ch 20V Fast Switching MOSFETs

#### CST3134 Typical Performance Characteristics

Figure 1: Output Characteristics

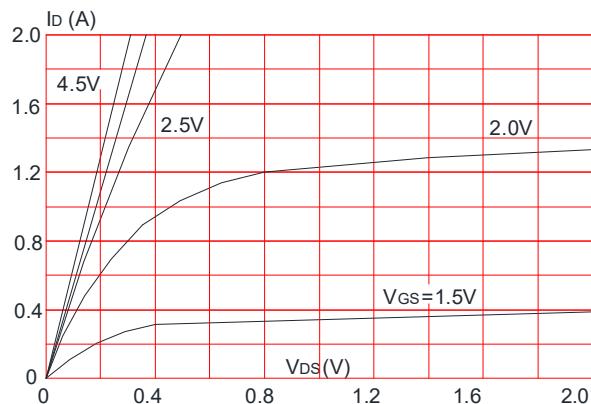


Figure 2: Typical Transfer Characteristics

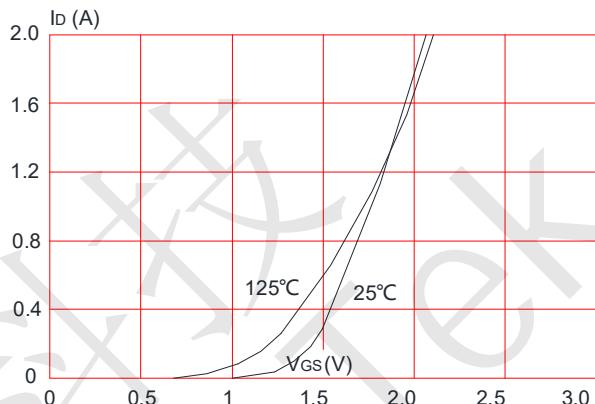


Figure 3: On-resistance vs. Drain Current

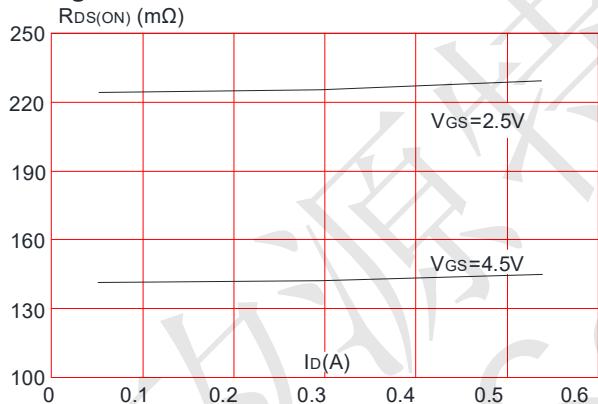


Figure 4: Body Diode Characteristics

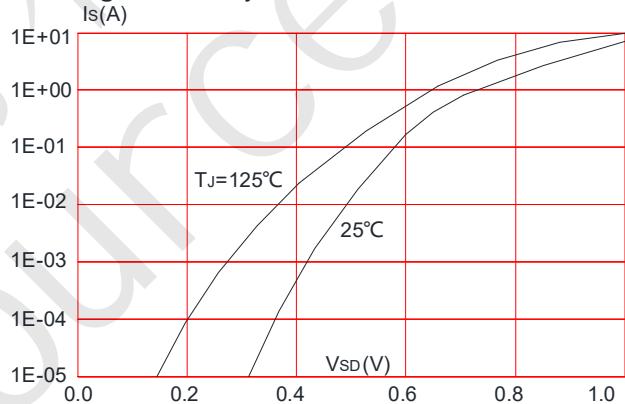


Figure 5: Gate Charge Characteristics

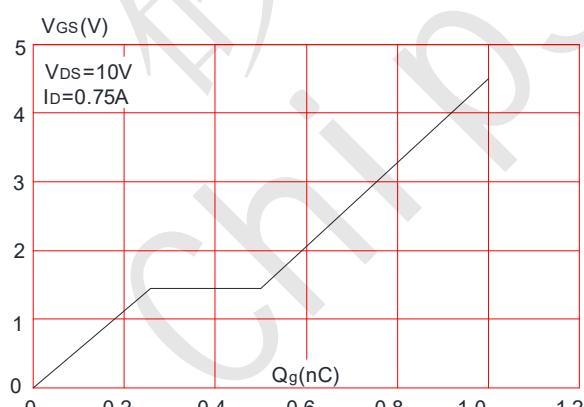
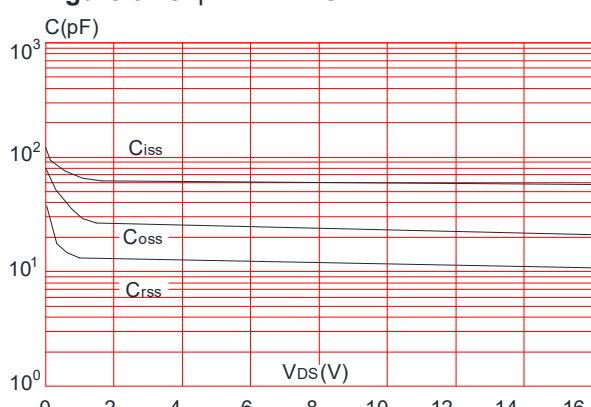


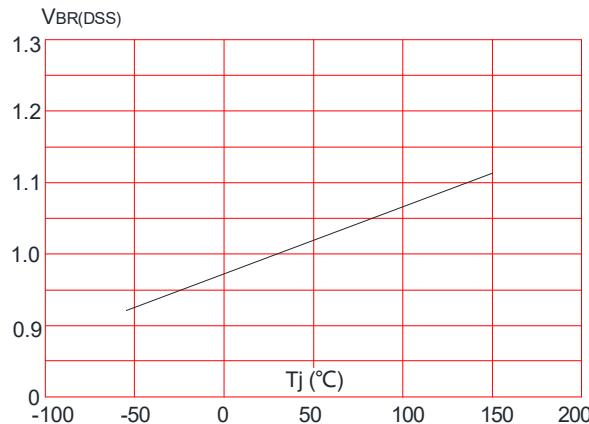
Figure 6: Capacitance Characteristics



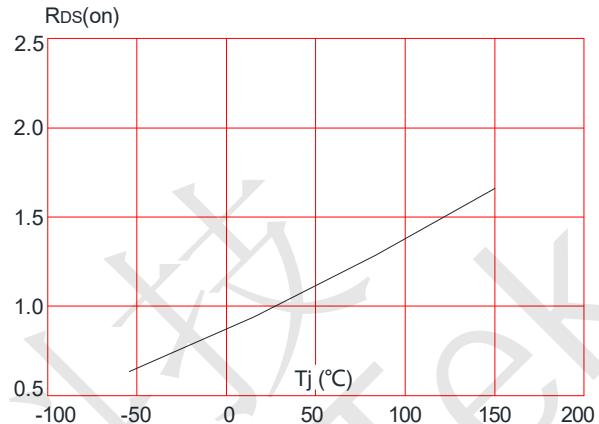


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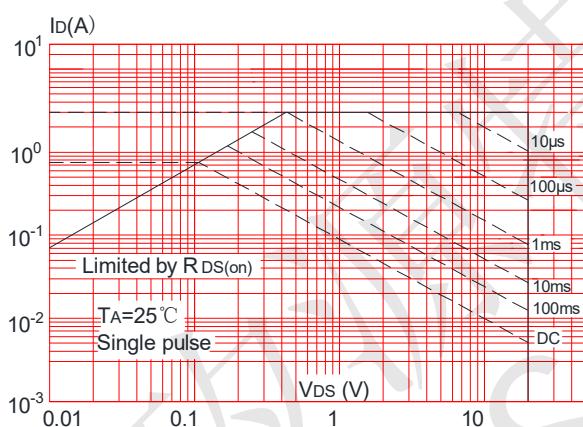
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



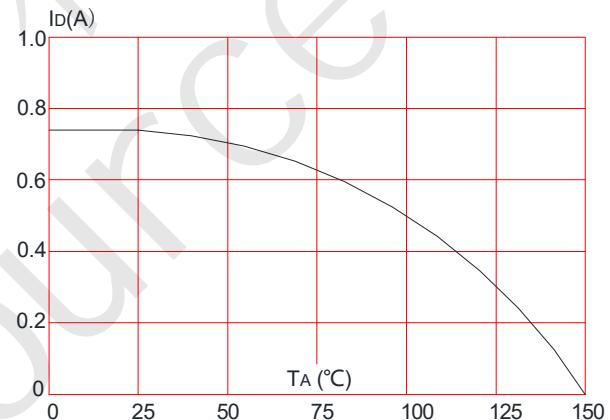
**Figure 8:** Normalized on Resistance vs. Junction Temperature



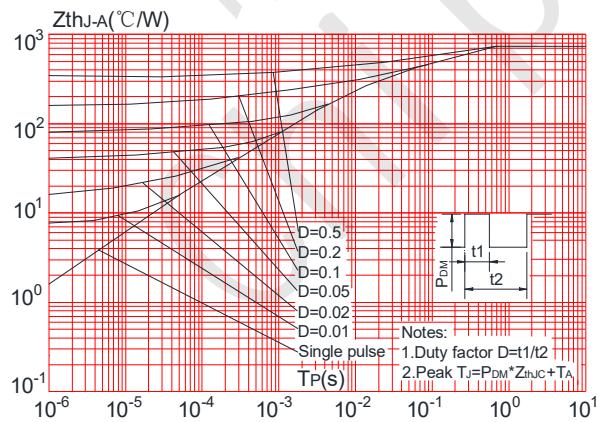
**Figure 9:** Maximum Safe Operating Area



**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature



**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



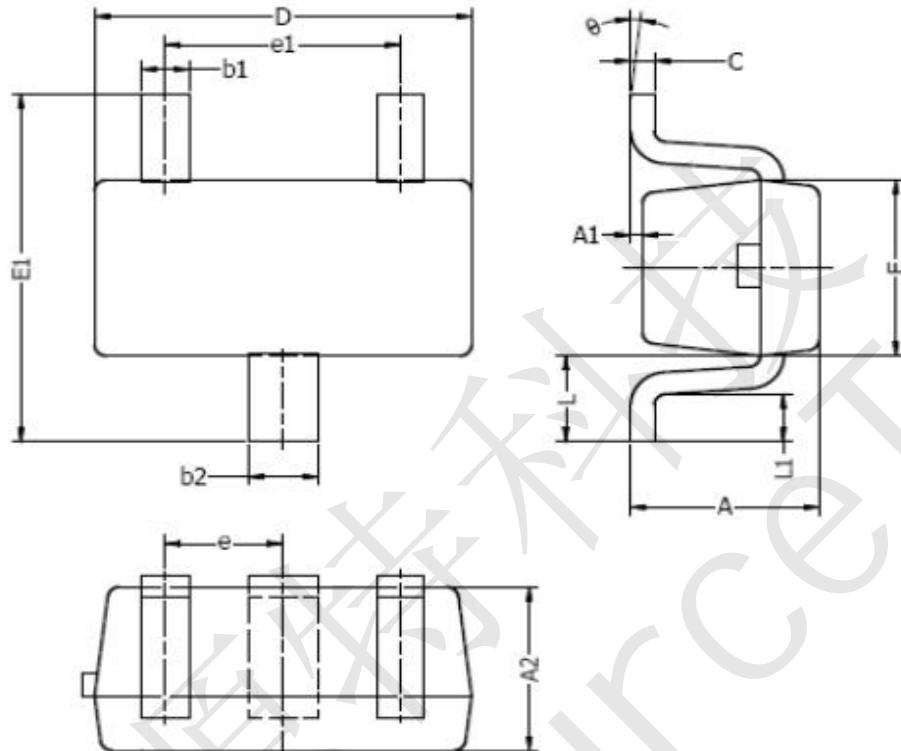


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### CST3134 N-Ch 20V Fast Switching MOSFETs

#### CST3134 Package Mechanical Data-SOT-523-3L



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.70	0.90	0.028	0.035
A1	0.00	0.10	0.000	0.004
A2	0.70	0.80	0.028	0.031
b1	0.15	0.25	0.006	0.010
b2	0.25	0.35	0.010	0.014
c	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
E1	1.45	1.75	0.057	0.069
e	0.50 TYP.		0.020 TYP.	
e1	0.90	1.10	0.035	0.043
L	0.40 REF.		0.016 REF.	
L1	0.10	0.30	0.004	0.012
theta	0°	8°	0°	8°

#### NOTES:

1. Above package outline conforms to JEITA EAJ ED-7500A SC-75A.
2. Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.

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